Lattice Semiconductor Corporation - LFEC1E-4TN100I Datasheet

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

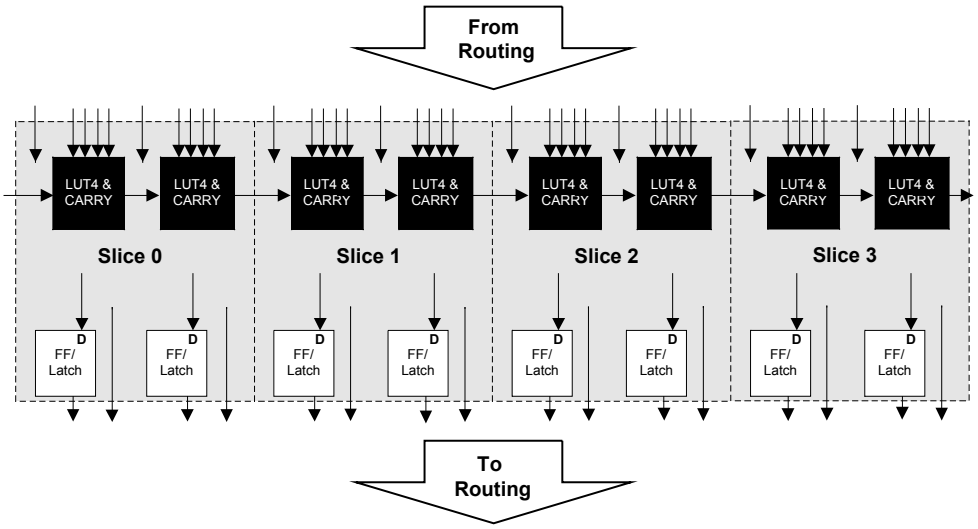
Details	
Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	1500
Total RAM Bits	18432
Number of I/O	67
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	100-LQFP
Supplier Device Package	100-TQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfec1e-4tn100i

PFU and PFF Blocks

The core of the LatticeECP/EC devices consists of PFU and PFF blocks. The PFUs can be programmed to perform Logic, Arithmetic, Distributed RAM and Distributed ROM functions. PFF blocks can be programmed to perform Logic, Arithmetic and ROM functions. Except where necessary, the remainder of the data sheet will use the term PFU to refer to both PFU and PFF blocks.

Each PFU block consists of four interconnected slices, numbered 0-3 as shown in Figure 2-3. All the interconnections to and from PFU blocks are from routing. There are 53 inputs and 25 outputs associated with each PFU block.

Figure 2-3. PFU Diagram

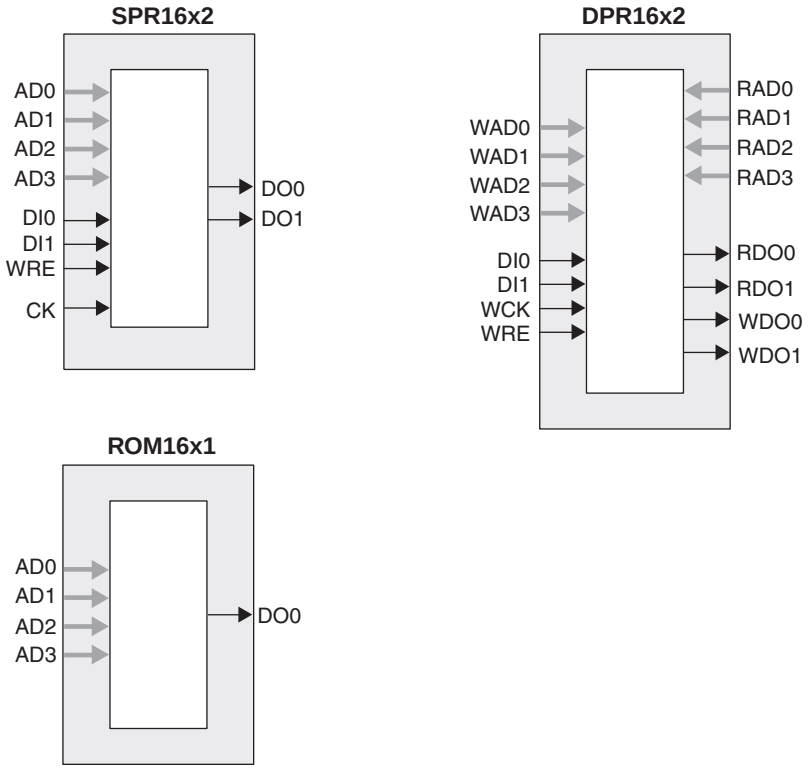


Slice

Each slice contains two LUT4 lookup tables feeding two registers (programmed to be in FF or Latch mode), and some associated logic that allows the LUTs to be combined to perform functions such as LUT5, LUT6, LUT7 and LUT8. There is control logic to perform set/reset functions (programmable as synchronous/asynchronous), clock select, chip-select and wider RAM/ROM functions. Figure 2-4 shows an overview of the internal logic of the slice. The registers in the slice can be configured for positive/negative and edge/level clocks.

There are 14 input signals: 13 signals from routing and one from the carry-chain (from adjacent slice or PFU). There are 7 outputs: 6 to routing and one to carry-chain (to adjacent PFU). Table 2-1 lists the signals associated with each slice.

Figure 2-5. Distributed Memory Primitives



ROM Mode: The ROM mode uses the same principal as the RAM modes, but without the Write port. Pre-loading is accomplished through the programming interface during configuration.

PFU Modes of Operation

Slices can be combined within a PFU to form larger functions. Table 2-4 tabulates these modes and documents the functionality possible at the PFU level.

Table 2-4. PFU Modes of Operation

Logic	Ripple	RAM[1]	ROM
LUT 4x8 or MUX 2x1 x 8	2-bit Add x 4	SPR16x2 x 4 DPR16x2 x 2	ROM16x1 x 8
LUT 5x4 or MUX 4x1 x 4	2-bit Sub x 4	SPR16x4 x 2 DPR16x4 x 1	ROM16x2 x 4
LUT 6x 2 or MUX 8x1 x 2	2-bit Counter x 4	SPR16x8 x 1	ROM16x4 x 2
LUT 7x1 or MUX 16x1 x 1	2-bit Comp x 4		ROM16x8 x 1

1. These modes are not available in PFF blocks

Table 2-5. PLL Signal Descriptions

Signal	I/O	Description
CLKI	I	Clock input from external pin or routing
CLKFB	I	PLL feedback input from CLKOP (PLL internal), from clock net (CLKOP) or from a user clock (PIN or logic)
RST	I	"1" to reset PLL
CLKOS	O	PLL output clock to clock tree (phase shifted/duty cycle changed)
CLKOP	O	PLL output clock to clock tree (No phase shift)
CLKOK	O	PLL output to clock tree through secondary clock divider
LOCK	O	"1" indicates PLL LOCK to CLKI
DDAMODE	I	Dynamic Delay Enable. "1": Pin control (dynamic), "0": Fuse Control (static)
DDAIZR	I	Dynamic Delay Zero. "1": delay = 0, "0": delay = on
DDAILAG	I	Dynamic Delay Lag/Lead. "1": Lead, "0": Lag
DDAIDEL[2:0]	I	Dynamic Delay Input
DDAOZR	O	Dynamic Delay Zero Output
DDAOLAG	O	Dynamic Delay Lag/Lead Output
DDAODEL[2:0]	O	Dynamic Delay Output

For more information about the PLL, please see the list of technical documentation at the end of this data sheet.

Dynamic Clock Select (DCS)

The DCS is a global clock buffer with smart multiplexer functions. It takes two independent input clock sources and outputs a clock signal without any glitches or runt pulses. This is achieved regardless of where the select signal is toggled. There are eight DCS blocks per device, located in pairs at the center of each side. Figure 2-13 illustrates the DCS Block Macro.

Figure 2-13. DCS Block Primitive

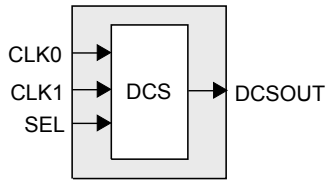


Figure 2-14 shows timing waveforms of the default DCS operating mode. The DCS block can be programmed to other modes. For more information about the DCS, please see the list of technical documentation at the end of this data sheet.

DC Electrical Characteristics

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{IL}, I_{IH}[1]	Input or I/O Leakage	0 ð V_{IN} ð (V_{CCIO} - 0.2V)	—	—	10	µA
I_{IH}[1, 3]	Input or I/O High Leakage	(V_{CCIO} - 0.2V) ð V_{IH} ð 3.6V	—	—	40	µA
I_{PU}	I/O Active Pull-up Current	0 ð V_{IN} ð 0.7 V_{CCIO}	-30	—	-150	µA
I_{PD}	I/O Active Pull-down Current	V_{IL} (MAX) ð V_{IN} ð V_{IH} (MAX)	30	—	150	µA
I_{BHLS}	Bus Hold Low sustaining current	V_{IN} = V_{IL} (MAX)	30	—	—	µA
I_{BHHS}	Bus Hold High sustaining current	V_{IN} = 0.7V_{CCIO}	-30	—	—	µA
I_{BHLO}	Bus Hold Low Overdrive current	0 ð V_{IN} ð V_{IH} (MAX)	—	—	150	µA
I_{BHLH}	Bus Hold High Overdrive current	0 ð V_{IN} ð V_{IH} (MAX)	—	—	-150	µA
V_{BHT}	Bus Hold trip Points	0 ð V_{IN} ð V_{IH} (MAX)	V_{IL} (MAX)	—	V_{IH} (MIN)	V
C1	I/O Capacitance[2]	V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V, V_{CC} = 1.2V, V_{IO} = 0 to V_{IH} (MAX)	—	8	—	pf
C2	Dedicated Input Capacitance[2]	V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V, V_{CC} = 1.2V, V_{IO} = 0 to V_{IH} (MAX)	—	6	—	pf

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tri-stated. It is not measured with the output driver active. Bus maintenance circuits are disabled.
2. T_A 25°C, f = 1.0MHz
3. For top and bottom general purpose I/O pins, when V_{IH} is higher than V_{CCIO}, a transient current typically of 30ns in duration or less with a peak current of 6mA can occur on the high-to-low transition. For left and right I/O banks, V_{IH} must be less than or equal to V_{CCIO}.

sysI/O Differential Electrical Characteristics

LVDS

Over Recommended Operating Conditions

Parameter Symbol	Parameter Description	Test Conditions	Min.	Typ.	Max.	Units
V_{INP}, V_{INM}	Input voltage		0	—	2.4	V
V_{THD}	Differential input threshold		+/-100	—	—	mV
V_{CM}	Input common mode voltage	100mV ð V_{THD}	V_{THD}/2	1.2	1.8	V
		200mV ð V_{THD}	V_{THD}/2	1.2	1.9	V
		350mV ð V_{THD}	V_{THD}/2	1.2	2.0	V
I_{IN}	Input current	Power on or power off	—	—	+/-10	µA
V_{OH}	Output high voltage for V_{OP} or V_{OM}	R_T = 100 Ohm	—	1.38	1.60	V
V_{OL}	Output low voltage for V_{OP} or V_{OM}	R_T = 100 Ohm	0.9V	1.03	—	V
V_{OD}	Output voltage differential	(V_{OP} - V_{OM}), R_T = 100 Ohm	250	350	450	mV
ΔV_{OD}	Change in V_{OD} between high and low		—	—	50	mV
V_{OS}	Output voltage offset	(V_{OP} + V_{OM})/2, R_T = 100 Ohm	1.125	1.25	1.375	V
ΔV_{OS}	Change in V_{OS} between H and L		—	—	50	mV
I_{OSD}	Output short circuit current	V_{OD} = 0V Driver outputs shorted	—	—	6	mA

LVPECL

The LatticeECP/EC devices support differential LVPECL standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The LVPECL input standard is supported by the LVDS differential input buffer. The scheme shown in Figure 3-3 is one possible solution for point-to-point signals.

Figure 3-3. Differential LVPECL

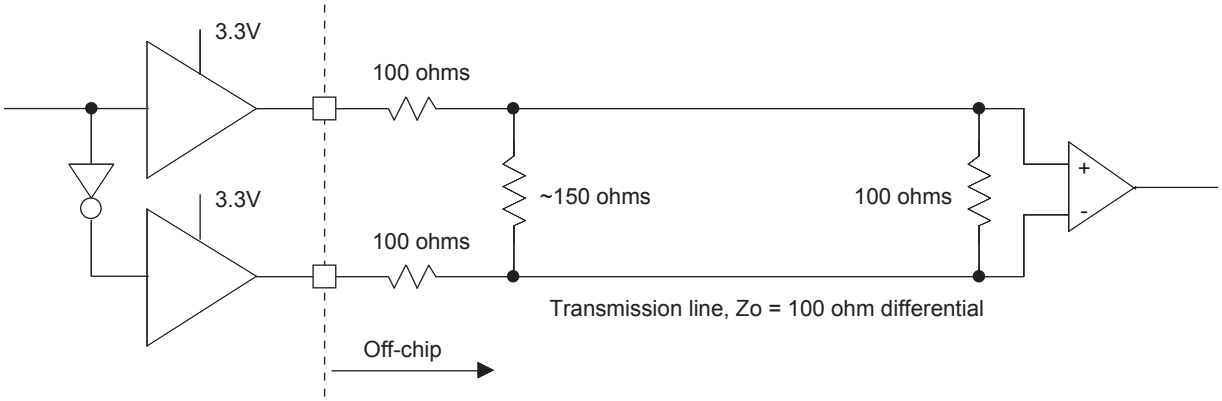


Table 3-3. LVPECL DC Conditions[1]

Over Recommended Operating Conditions

Parameter	Description	Typical	Units
Z_{OUT}	Output impedance	100	ohm
R_P	Driver parallel resistor	150	ohm
R_T	Receiver termination	100	ohm
V_{OH}	Output high voltage	2.03	V
V_{OL}	Output low voltage	1.27	V
V_{OD}	Output differential voltage	0.76	V
V_{CM}	Output common mode voltage	1.65	V
Z_{BACK}	Back impedance	85.7	ohm
I_{DC}	DC output current	12.7	mA

1. For input buffer, see LVDS table.

For further information about LVPECL, BLVDS and other differential interfaces please see the list of technical information at the end of this data sheet.

Typical Building Block Function Performance

Pin-to-Pin Performance (LVCMOS25 12mA Drive)

Function	-5 Timing	Units
Basic Functions		
16-bit decoder	5.5	ns
32-bit decoder	6.9	ns
64-bit decoder	7.1	ns
4:1 MUX	4.3	ns
8:1 MUX	4.7	ns
16:1 MUX	5.0	ns
32:1 MUX	5.5	ns

Register-to-Register Performance[1]

Function	-5 Timing	Units
Basic Functions		
16 bit decoder	410	MHz
32 bit decoder	283	MHz
64 bit decoder	272	MHz
4:1 MUX	613	MHz
8:1 MUX	565	MHz
16:1 MUX	526	MHz
32:1 MUX	442	MHz
8-bit adder	363	MHz
16-bit adder	353	MHz
64-bit adder	196	MHz
16-bit counter	414	MHz
32-bit counter	317	MHz
64-bit counter	216	MHz
64-bit accumulator	178	MHz
Embedded Memory Functions		
256x36 Single Port RAM	280	MHz
512x18 True-Dual Port RAM	280	MHz
Distributed Memory Functions		
16x2 Single Port RAM	460	MHz
64x2 Single Port RAM	375	MHz
128x4 Single Port RAM	294	MHz
32x2 Pseudo-Dual Port RAM	392	MHz
64x4 Pseudo-Dual Port RAM	332	MHz
DSP Function[2]		
9x9 Pipelined Multiply/Accumulate	242	MHz
18x18 Pipelined Multiply/Accumulate	238	MHz
36x36 Pipelined Multiply	235	MHz

1. These timing numbers were generated using the ispLEVER design tool. Exact performance may vary with design and tool version. The tool uses internal parameters that have been characterized but are not tested on every device.
2. Applies to LatticeECP devices only.

Timing v.G 0.30

LatticeECP/EC sysCONFIG Port Timing Specifications (Continued)

Over Recommended Operating Conditions

Parameter	Description	Min.	Typ.	Max.	Units
t_{SOE}	CSSPIN Active Setup Time	300		—	ns
t_{CSPID}	CSSPIN Low to First Clock Edge Setup Time	300+3cyc		600+6cyc	ns
f_{MAXSPI}	Max Frequency for SPI	—		25	MHz
t_{SUSPI}	SOSPI Data Setup Time Before CCLK	7		—	ns
t_{HSPI}	SOSPI Data Hold Time After CCLK	1		—	ns

Timing v.G 0.30

Master Clock

Clock Mode	Min.	Typ.	Max.	Units
2.5MHz	1.75	2.5	3.25	MHz
5 MHz	3.78	5.4	7.02	MHz
10 MHz	7	10	13	MHz
15 MHz	10.5	15	19.5	MHz
20 MHz	14	20	26	MHz
25 MHz	18.2	26	33.8	MHz
30 MHz	21	30	39	MHz
35 MHz	23.8	34	44.2	MHz
40 MHz	28.7	41	53.3	MHz
45 MHz	31.5	45	58.5	MHz
50 MHz	35.7	51	66.3	MHz
55 MHz	38.5	55	71.5	MHz
60 MHz	42	60	78	MHz
Duty Cycle	40	—	60	%

Timing v.G 0.30

Signal Descriptions

Signal Name	I/O	Description
General Purpose		
P[Edge] [Row/Column Number*]_[A/B]	I/O	[Edge] indicates the edge of the device on which the pad is located. Valid edge designations are L (Left), B (Bottom), R (Right), T (Top). [Row/Column Number] indicates the PFU row or the column of the device on which the PIC exists. When Edge is T (Top) or (Bottom), only need to specify Row Number. When Edge is L (Left) or R (Right), only need to specify Column Number. [A/B] indicates the PIO within the PIC to which the pad is connected. Some of these user-programmable pins are shared with special function pins. These pin when not used as special purpose pins can be programmed as I/Os for user logic. During configuration the user-programmable I/Os are tri-stated with an internal pull-up resistor enabled. If any pin is not used (or not bonded to a package pin), it is also tri-stated with an internal pull-up resistor enabled after configuration.
GSRN	I	Global RESET signal (active low). Any I/O pin can be GSRN.
NC	—	No connect.
GND	—	Ground. Dedicated pins.
V_{CC}	—	Power supply pins for core logic. Dedicated pins.
V_{CCAUX}	—	Auxiliary power supply pin. It powers all the differential and referenced input buffers. Dedicated pins.
V_{CCIOx}	—	Power supply pins for I/O bank x. Dedicated pins.
V_{REF1_x}, V_{REF2_x}	—	Reference supply pins for I/O bank x. Pre-determined pins in each bank are assigned as V_{REF} inputs. When not used, they may be used as I/O pins.
XRES	—	10K ohm +/-1% resistor must be connected between this pad and ground.
V_{CCPLL}	—	Power supply pin for PLL.þApplicable to ECP/EC33 device.
PLL and Clock Functions (Used as user programmable I/O pins when not in use for PLL or clock pins)		
[LOC][num]_PLL[T, C]_IN_A	I	Reference clock (PLL) input pads: ULM, LLM, URM, LRM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_PLL[T, C]_FB_A	I	Optional feedback (PLL) input pads: ULM, LLM, URM, LRM, num = row from center, T = true and C = complement, index A,B,C...at each side.
PCLK[T, C]_[n:0]_[3:0]	I	Primary Clock pads, T = true and C = complement, n per side, indexed by bank and 0,1,2,3 within bank.
[LOC]DQS[num]	I	DQS input pads: T (Top), R (Right), B (Bottom), L (Left), DQS, num = ball function number. Any pad can be configured to be output.
Test and Programming (Dedicated pins)		
TMS	I	Test Mode Select input, used to control the 1149.1 state machine. Pull-up is enabled during configuration.
TCK	I	Test Clock input pin, used to clock the 1149.1 state machine. No pull-up enabled.

Signal Descriptions (Cont.)

Signal Name	I/O	Description
TDI	I	Test Data in pin. Used to load data into device using 1149.1 state machine. After power-up, this TAP port can be activated for configuration by sending appropriate command. (Note: once a configuration port is selected it is locked. Another configuration port cannot be selected until the power-up sequence). Pull-up is enabled during configuration.
TDO	O	Output pin. Test Data out pin used to shift data out of device using 1149.1.
V_{CCJ}	—	V_{CCJ} - The power supply pin for JTAG Test Access Port.
Configuration Pads (used during sysCONFIG)		
CFG[2:0]	I	Mode pins used to specify configuration modes values latched on rising edge of INITN. During configuration, a pull-up is enabled. These are dedicated pins.
INITN	I/O	Open Drain pin. Indicates the FPGA is ready to be configured. During configuration, a pull-up is enabled. It is a dedicated pin.
PROGRAMN	I	Initiates configuration sequence when asserted low. This pin always has an active pull-up. This is a dedicated pin.
DONE	I/O	Open Drain pin. Indicates that the configuration sequence is complete, and the startup sequence is in progress. This is a dedicated pin.
CCLK	I/O	Configuration Clock for configuring an FPGA in sysCONFIG mode.
BUSY/SISPI	I/O	Read control command in SPI3 or SPIX mode.
CSN	I	sysCONFIG chip select (Active low). During configuration, a pull-up is enabled.
CS1N	I	sysCONFIG chip select (Active low). During configuration, a pull-up is enabled.
WRITEN	I	Write Data on Parallel port (Active low).
D[7:0]/SPID[0:7]	I/O	sysCONFIG Port Data I/O.
DOUT/CSON	O	Output for serial configuration data (rising edge of CCLK) when using sysCONFIG port.
DI/CSSPIN	I/O	Input for serial configuration data (clocked with CCLK) when using sysCONFIG port. During configuration, a pull-up is enabled. Output when used in SPI/SPIX modes.

LFEC1, LFEC3 Logic Signal Connections: 208 PQFP

Pin Number	LFEC1				LFEC3			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
1*	GND0 GND7	-			GND0 GND7	-		
2	VCCIO7	7			VCCIO7	7		
3	PL2A	7	T	VREF2_7	PL2A	7	T	VREF2_7
4	PL2B	7	C	VREF1_7	PL2B	7	C	VREF1_7
5	NC	-			NC	-		
6	NC	-			NC	-		
7	NC	-			PL3B	7		
8	NC	-			PL4A	7	T	
9	NC	-			PL4B	7	C	
10	NC	-			PL5A	7	T	
11	NC	-			PL5B	7	C	
12	NC	-			PL6A	7	T	LDQS6
13	NC	-			VCCIO7	7		
14	NC	-			PL6B	7	C	
15	PL3A	7	T		PL7A	7	T	
16	PL3B	7	C		PL7B	7	C	
17	PL4A	7	T		PL8A	7	T	
18	NC	-			NC	-		
19	PL4B	7	C		PL8B	7	C	
20	PL5A	7	T	PCLKT7_0	PL9A	7	T	PCLKT7_0
21	PL5B	7	C	PCLKC7_0	PL9B	7	C	PCLKC7_0
22	NC	-			VCCAUX	-		
23	XRES	6			XRES	6		
24	NC	-			NC	-		
25	NC	-			NC	-		
26	VCC	-			VCC	-		
27	TCK	6			TCK	6		
28	GND	-			GND	-		
29	TDI	6			TDI	6		
30	TMS	6			TMS	6		
31	TDO	6			TDO	6		
32	VCCJ	6			VCCJ	6		
33	PL7A	6	T	LLM0_PLLT_IN_A	PL11A	6	T	LLM0_PLLT_IN_A
34	PL7B	6	C	LLM0_PLLC_IN_A	PL11B	6	C	LLM0_PLLC_IN_A
35	PL8A	6	T	LLM0_PLLT_FB_A	PL12A	6	T	LLM0_PLLT_FB_A
36	PL8B	6	C	LLM0_PLLC_FB_A	PL12B	6	C	LLM0_PLLC_FB_A
37	VCCIO6	6			VCCIO6	6		
38	PL9A	6	T		PL13A	6	T	
39	PL9B	6	C		PL13B	6	C	
40	PL10A	6	T		PL14A	6	T	
41	GND6	6			GND6	6		
42	PL10B	6	C		PL14B	6	C	

LFEC3 and LFECP/EC6 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFEC3				LFECP6/LFEC6			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
GND	GND5	5			GND5	5		
T9	PB13B	5	C		PB13B	5	C	
P8	PB14A	5	T	BDQS14	PB14A	5	T	BDQS14
N8	PB14B	5	C		PB14B	5	C	
R9	PB15A	5	T		PB15A	5	T	
R10	PB15B	5	C		PB15B	5	C	
P9	PB16A	5	T	VREF2_5	PB16A	5	T	VREF2_5
N9	PB16B	5	C	VREF1_5	PB16B	5	C	VREF1_5
T10	PB17A	5	T	PCLKT5_0	PB17A	5	T	PCLKT5_0
GND	GND5	5			GND5	5		
T11	PB17B	5	C	PCLKC5_0	PB17B	5	C	PCLKC5_0
T12	PB18A	4	T	WRITEN	PB18A	4	T	WRITEN
T13	PB18B	4	C	CS1N	PB18B	4	C	CS1N
P10	PB19A	4	T	VREF1_4	PB19A	4	T	VREF1_4
N10	PB19B	4	C	CSN	PB19B	4	C	CSN
T14	PB20A	4	T	VREF2_4	PB20A	4	T	VREF2_4
T15	PB20B	4	C	D0/SPID7	PB20B	4	C	D0/SPID7
M10	PB21A	4	T	D2/SPID5	PB21A	4	T	D2/SPID5
GND	GND4	4			GND4	4		
M11	PB21B	4	C	D1/SPID6	PB21B	4	C	D1/SPID6
R11	PB22A	4	T	BDQS22	PB22A	4	T	BDQS22
P11	PB22B	4	C	D3/SPID4	PB22B	4	C	D3/SPID4
R13	PB23A	4	T		PB23A	4	T	
R14	PB23B	4	C	D4/SPID3	PB23B	4	C	D4/SPID3
P12	PB24A	4	T		PB24A	4	T	
P13	PB24B	4	C	D5/SPID2	PB24B	4	C	D5/SPID2
N11	PB25A	4	T		PB25A	4	T	
-	-	-			GND4	4		
N12	PB25B	4	C	D6/SPID1	PB25B	4	C	D6/SPID1
R12	NC	-			PB26A	4		
GND	GND4	4			GND4	4		
-	-	-			GND4	4		
GND	GND3	3			GND3	3		
N13	PR18B	3	C	VREF2_3	PR27B	3	C	VREF2_3
N14	PR18A	3	T	VREF1_3	PR27A	3	T	VREF1_3
P14	PR17B	3	C		PR26B	3	C	
P15	PR17A	3	T		PR26A	3	T	
R15	PR16B	3	C		PR25B	3	C	
R16	PR16A	3	T		PR25A	3	T	
M13	PR15B	3	C		PR24B	3	C	
M14	PR15A	3	T	RDQS15	PR24A	3	T	RDQS24
P16	PR14B	3	C	RLM0_PLLC_FB_A	PR23B	3	C	RLM0_PLLC_FB_A
GND	GND3	3			GND3	3		

LFECP/EC10 and LFECP/EC15 Logic Signal Connections: 256 fpBGA

Ball Number	LFECP10/LFEC10				LFECP15/LFEC15			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
GND	GND7	7			GND7	7		
D4	PL2A	7	T	VREF2_7	PL2A	7	T	VREF2_7
D3	PL2B	7	C	VREF1_7	PL2B	7	C	VREF1_7
GND	GND7	7			GND7	7		
C3	PL12A	7	T		PL16A	7	T	
C2	PL12B	7	C		PL16B	7	C	
B1	PL13A	7	T		PL17A	7	T	
C1	PL13B	7	C		PL17B	7	C	
E3	PL14A	7	T		PL18A	7	T	
GND	GND7	7			GND7	7		
-	-	-			GND7	7		
E4	PL14B	7	C		PL18B	7	C	
F4	PL15A	7	T	LDQS15	PL19A	7	T	LDQS19
F5	PL15B	7	C		PL19B	7	C	
G4	PL16A	7	T		PL20A	7	T	
G3	PL16B	7	C		PL20B	7	C	
D2	PL17A	7	T		PL21A	7	T	
D1	PL17B	7	C		PL21B	7	C	
E1	PL18A	7	T	PCLKT7_0	PL22A	7	T	PCLKT7_0
GND	GND7	7			GND7	7		
E2	PL18B	7	C	PCLKC7_0	PL22B	7	C	PCLKC7_0
F3	XRES	6			XRES	6		
G5	PL20A	6	T		PL24A	6	T	
H5	PL20B	6	C		PL24B	6	C	
F2	PL21A	6	T		PL25A	6	T	
F1	PL21B	6	C		PL25B	6	C	
H4	PL22A	6	T		PL26A	6	T	
H3	PL22B	6	C		PL26B	6	C	
G2	PL23A	6	T		PL27A	6	T	
GND	GND6	6			GND6	6		
G1	PL23B	6	C		PL27B	6	C	
J4	PL24A	6	T	LDQS24	PL28A	6	T	LDQS28
J3	PL24B	6	C		PL28B	6	C	
J5	PL25A	6	T		PL29A	6	T	
K5	PL25B	6	C		PL29B	6	C	
H2	PL26A	6	T		PL30A	6	T	
H1	PL26B	6	C		PL30B	6	C	
J2	PL27A	6	T		PL31A	6	T	
GND	GND6	6			GND6	6		
J1	PL27B	6	C		PL31B	6	C	
K4	TCK	6			TCK	6		
K3	TDI	6			TDI	6		

LFECP/EC20 and LFECP/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFECP20/LFEC20					LFECP/LFEC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
V2	PL41B	6	C	LLM0_PLLC_IN_A	V2	PL53B	6	C	LLM0_PLLC_IN_A
U3	PL42A	6	T	LLM0_PLLT_FB_A	U3	PL54A	6	T	LLM0_PLLT_FB_A
V3	PL42B	6	C	LLM0_PLLC_FB_A	V3	PL54B	6	C	LLM0_PLLC_FB_A
U4	PL43A	6	T		U4	PL55A	6	T	
V5	PL43B	6	C		V5	PL55B	6	C	
W1	PL44A	6	T		W1	PL56A	6	T	
GND	GND6	6			GND	GND6	6		
W2	PL44B	6	C		W2	PL56B	6	C	
Y1	PL45A	6	T	LDQS45	Y1	PL57A	6	T	LDQS57
Y2	PL45B	6	C		Y2	PL57B	6	C	
AA1	PL46A	6	T		AA1	PL58A	6	T	
AA2	PL46B	6	C		AA2	PL58B	6	C	
W4	PL47A	6	T		W4	PL59A	6	T	
V4	PL47B	6	C		V4	PL59B	6	C	
W3	PL48A	6	T	VREF1_6	W3	PL68A	6	T	VREF1_6
Y3	PL48B	6	C	VREF2_6	Y3	PL68B	6	C	VREF2_6
GND	GND6	6			GND	GND6	6		
GND	GND5	5			GND	GND6	6		
GND	-				GND	GND6	6		
GND	-				GND	GND5	5		
GND	GND5	5			GND	GND5	5		
V7	PB10A	5	T		V7	PB10A	5	T	
T6	PB10B	5	C		T6	PB10B	5	C	
V8	PB11A	5	T		V8	PB11A	5	T	
U7	PB11B	5	C		U7	PB11B	5	C	
W5	PB12A	5	T		W5	PB12A	5	T	
U6	PB12B	5	C		U6	PB12B	5	C	
AA3	PB13A	5	T		AA3	PB13A	5	T	
GND	GND5	5			GND	GND5	5		
AB3	PB13B	5	C		AB3	PB13B	5	C	
Y6	PB14A	5	T	BDQS14	Y6	PB14A	5	T	BDQS14
V6	PB14B	5	C		V6	PB14B	5	C	
AA5	PB15A	5	T		AA5	PB15A	5	T	
W6	PB15B	5	C		W6	PB15B	5	C	
Y5	PB16A	5	T		Y5	PB16A	5	T	
Y4	PB16B	5	C		Y4	PB16B	5	C	
AA4	PB17A	5	T		AA4	PB17A	5	T	
GND	GND5	5			GND	GND5	5		
AB4	PB17B	5	C		AB4	PB17B	5	C	
Y7	PB18A	5	T		Y7	PB18A	5	T	
W8	PB18B	5	C		W8	PB18B	5	C	
W7	PB19A	5	T		W7	PB19A	5	T	
U8	PB19B	5	C		U8	PB19B	5	C	
W9	PB20A	5	T		W9	PB20A	5	T	

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
A21	PT51A	1	T		A21	PT51A	1	T	
E17	PT50B	1	C		E17	PT50B	1	C	
B17	PT50A	1	T		B17	PT50A	1	T	
C17	PT49B	1	C		C17	PT49B	1	C	
GND	GND1	1			GND	GND1	1		
D17	PT49A	1	T		D17	PT49A	1	T	
F17	PT48B	1	C		F17	PT48B	1	C	
E20	PT48A	1	T		E20	PT48A	1	T	
G17	PT47B	1	C		G17	PT47B	1	C	
B20	PT47A	1	T		B20	PT47A	1	T	
E16	PT46B	1	C		E16	PT46B	1	C	
A20	PT46A	1	T	TDQS46	A20	PT46A	1	T	TDQS46
A19	PT45B	1	C		A19	PT45B	1	C	
GND	GND1	1			GND	GND1	1		
B19	PT45A	1	T		B19	PT45A	1	T	
D16	PT44B	1	C		D16	PT44B	1	C	
C16	PT44A	1	T		C16	PT44A	1	T	
F16	PT43B	1	C		F16	PT43B	1	C	
A18	PT43A	1	T		A18	PT43A	1	T	
G16	PT42B	1	C		G16	PT42B	1	C	
B18	PT42A	1	T		B18	PT42A	1	T	
A17	PT41B	1	C		A17	PT41B	1	C	
GND	GND1	1			GND	GND1	1		
A16	PT41A	1	T		A16	PT41A	1	T	
D15	PT40B	1	C		D15	PT40B	1	C	
B16	PT40A	1	T		B16	PT40A	1	T	
E15	PT39B	1	C		E15	PT39B	1	C	
C15	PT39A	1	T		C15	PT39A	1	T	
F15	PT38B	1	C		F15	PT38B	1	C	
G15	PT38A	1	T	TDQS38	G15	PT38A	1	T	TDQS38
B15	PT37B	1	C		B15	PT37B	1	C	
GND	GND1	1			GND	GND1	1		
A15	PT37A	1	T		A15	PT37A	1	T	
E14	PT36B	1	C		E14	PT36B	1	C	
G14	PT36A	1	T		G14	PT36A	1	T	
D14	PT35B	1	C	VREF2_1	D14	PT35B	1	C	VREF2_1
E13	PT35A	1	T	VREF1_1	E13	PT35A	1	T	VREF1_1
F14	PT34B	1	C		F14	PT34B	1	C	
C14	PT34A	1	T		C14	PT34A	1	T	
B14	PT33B	0	C	PCLKC0_0	B14	PT33B	0	C	PCLKC0_0
GND	GND0	0			GND	GND0	0		
A14	PT33A	0	T	PCLKT0_0	A14	PT33A	0	T	PCLKT0_0

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
A5	PT13B	0	C		A5	PT13B	0	C	
GND	GND0	0			GND	GND0	0		
A4	PT13A	0	T		A4	PT13A	0	T	
F9	PT12B	0	C		F9	PT12B	0	C	
B6	PT12A	0	T		B6	PT12A	0	T	
E9	PT11B	0	C		E9	PT11B	0	C	
C8	PT11A	0	T		C8	PT11A	0	T	
G8	PT10B	0	C		G8	PT10B	0	C	
B5	PT10A	0	T		B5	PT10A	0	T	
A3	PT9B	0	C		A3	PT9B	0	C	
GND	GND0	0			GND	GND0	0		
A2	PT9A	0	T		A2	PT9A	0	T	
F8	PT8B	0	C		F8	PT8B	0	C	
B4	PT8A	0	T		B4	PT8A	0	T	
E8	PT7B	0	C		E8	PT7B	0	C	
B3	PT7A	0	T		B3	PT7A	0	T	
D8	PT6B	0	C		D8	PT6B	0	C	
G7	PT6A	0	T	TDQS6	G7	PT6A	0	T	TDQS6
C4	PT5B	0	C		C4	PT5B	0	C	
C5	PT5A	0	T		C5	PT5A	0	T	
E7	PT4B	0	C		E7	PT4B	0	C	
D4	PT4A	0	T		D4	PT4A	0	T	
F7	PT3B	0	C		F7	PT3B	0	C	
D6	PT3A	0	T		D6	PT3A	0	T	
D7	PT2B	0	C		D7	PT2B	0	C	
E6	PT2A	0	T		E6	PT2A	0	T	
GND	GND0	0			GND	GND0	0		
K10	GND	-			K10	GND	-		
K11	GND	-			K11	GND	-		
K12	GND	-			K12	GND	-		
K13	GND	-			K13	GND	-		
K14	GND	-			K14	GND	-		
K15	GND	-			K15	GND	-		
K16	GND	-			K16	GND	-		
L10	GND	-			L10	GND	-		
L11	GND	-			L11	GND	-		
L12	GND	-			L12	GND	-		
L13	GND	-			L13	GND	-		
L14	GND	-			L14	GND	-		
L15	GND	-			L15	GND	-		
L16	GND	-			L16	GND	-		
L17	GND	-			L17	GND	-		

Conventional Packaging

LatticeEC Commercial

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC1E-3Q208C	112	-3	PQFP	208	COM	1.5K
LFEC1E-4Q208C	112	-4	PQFP	208	COM	1.5K
LFEC1E-5Q208C	112	-5	PQFP	208	COM	1.5K
LFEC1E-3T144C	97	-3	TQFP	144	COM	1.5K
LFEC1E-4T144C	97	-4	TQFP	144	COM	1.5K
LFEC1E-5T144C	97	-5	TQFP	144	COM	1.5K
LFEC1E-3T100C	67	-3	TQFP	100	COM	1.5K
LFEC1E-4T100C	67	-4	TQFP	100	COM	1.5K
LFEC1E-5T100C	67	-5	TQFP	100	COM	1.5K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC3E-3F256C	160	-3	fpBGA	256	COM	3.1K
LFEC3E-4F256C	160	-4	fpBGA	256	COM	3.1K
LFEC3E-5F256C	160	-5	fpBGA	256	COM	3.1K
LFEC3E-3Q208C	145	-3	PQFP	208	COM	3.1K
LFEC3E-4Q208C	145	-4	PQFP	208	COM	3.1K
LFEC3E-5Q208C	145	-5	PQFP	208	COM	3.1K
LFEC3E-3T144C	97	-3	TQFP	144	COM	3.1K
LFEC3E-4T144C	97	-4	TQFP	144	COM	3.1K
LFEC3E-5T144C	97	-5	TQFP	144	COM	3.1K
LFEC3E-3T100C	67	-3	TQFP	100	COM	3.1K
LFEC3E-4T100C	67	-4	TQFP	100	COM	3.1K
LFEC3E-5T100C	67	-5	TQFP	100	COM	3.1K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC6E-3F484C	224	-3	fpBGA	484	COM	6.1K
LFEC6E-4F484C	224	-4	fpBGA	484	COM	6.1K
LFEC6E-5F484C	224	-5	fpBGA	484	COM	6.1K
LFEC6E-3F256C	195	-3	fpBGA	256	COM	6.1K
LFEC6E-4F256C	195	-4	fpBGA	256	COM	6.1K
LFEC6E-5F256C	195	-5	fpBGA	256	COM	6.1K
LFEC6E-3Q208C	147	-3	PQFP	208	COM	6.1K
LFEC6E-4Q208C	147	-4	PQFP	208	COM	6.1K
LFEC6E-5Q208C	147	-5	PQFP	208	COM	6.1K
LFEC6E-3T144C	97	-3	TQFP	144	COM	6.1K
LFEC6E-4T144C	97	-4	TQFP	144	COM	6.1K
LFEC6E-5T144C	97	-5	TQFP	144	COM	6.1K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC10E-3F484C	288	-3	fpBGA	484	COM	10.2K
LFEC10E-4F484C	288	-4	fpBGA	484	COM	10.2K
LFEC10E-5F484C	288	-5	fpBGA	484	COM	10.2K
LFEC10E-3F256C	195	-3	fpBGA	256	COM	10.2K

LatticeECP Commercial

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFECP6E-3F484C	224	-3	fpBGA	484	COM	6.1K
LFECP6E-4F484C	224	-4	fpBGA	484	COM	6.1K
LFECP6E-5F484C	224	-5	fpBGA	484	COM	6.1K
LFECP6E-3F256C	195	-3	fpBGA	256	COM	6.1K
LFECP6E-4F256C	195	-4	fpBGA	256	COM	6.1K
LFECP6E-5F256C	195	-5	fpBGA	256	COM	6.1K
LFECP6E-3Q208C	147	-3	PQFP	208	COM	6.1K
LFECP6E-4Q208C	147	-4	PQFP	208	COM	6.1K
LFECP6E-5Q208C	147	-5	PQFP	208	COM	6.1K
LFECP6E-3T144C	97	-3	TQFP	144	COM	6.1K
LFECP6E-4T144C	97	-4	TQFP	144	COM	6.1K
LFECP6E-5T144C	97	-5	TQFP	144	COM	6.1K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFECP10E-3F484C	288	-3	fpBGA	484	COM	10.2K
LFECP10E-4F484C	288	-4	fpBGA	484	COM	10.2K
LFECP10E-5F484C	288	-5	fpBGA	484	COM	10.2K
LFECP10E-3F256C	195	-3	fpBGA	256	COM	10.2K
LFECP10E-4F256C	195	-4	fpBGA	256	COM	10.2K
LFECP10E-5F256C	195	-5	fpBGA	256	COM	10.2K
LFECP10E-3Q208C	147	-3	PQFP	208	COM	10.2K
LFECP10E-4Q208C	147	-4	PQFP	208	COM	10.2K
LFECP10E-5Q208C	147	-5	PQFP	208	COM	10.2K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFECP15E-3F484C	352	-3	fpBGA	484	COM	15.3K
LFECP15E-4F484C	352	-4	fpBGA	484	COM	15.3K
LFECP15E-5F484C	352	-5	fpBGA	484	COM	15.3K
LFECP15E-3F256C	195	-3	fpBGA	256	COM	15.3K
LFECP15E-4F256C	195	-4	fpBGA	256	COM	15.3K
LFECP15E-5F256C	195	-5	fpBGA	256	COM	15.3K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFECP20E-3F672C	400	-3	fpBGA	672	COM	19.7K
LFECP20E-4F672C	400	-4	fpBGA	672	COM	19.7K
LFECP20E-5F672C	400	-5	fpBGA	672	COM	19.7K
LFECP20E-3F484C	360	-3	fpBGA	484	COM	19.7K
LFECP20E-4F484C	360	-4	fpBGA	484	COM	19.7K
LFECP20E-5F484C	360	-5	fpBGA	484	COM	19.7K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFECP33E-3F672C	496	-3	fpBGA	672	COM	32.8K
LFECP33E-4F672C	496	-4	fpBGA	672	COM	32.8K
LFECP33E-5F672C	496	-5	fpBGA	672	COM	32.8K

LatticeECP Industrial (Continued)

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFECP20E-3F672I	400	-3	fpBGA	672	IND	19.7K
LFECP20E-4F672I	400	-4	fpBGA	672	IND	19.7K
LFECP20E-3F484I	360	-3	fpBGA	484	IND	19.7K
LFECP20E-4F484I	360	-4	fpBGA	484	IND	19.7K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFECP33E-3F672I	496	-3	fpBGA	672	IND	32.8K
LFECP33E-4F672I	496	-4	fpBGA	672	IND	32.8K
LFECP33E-3F484I	360	-3	fpBGA	484	IND	32.8K
LFECP33E-4F484I	360	-4	fpBGA	484	IND	32.8K

LatticeECP/EC Family Data Sheet Supplemental Information

For Further Information

A variety of technical notes for the LatticeECP/EC family are available on the Lattice web site at www.latticesemi.com.

- LatticeECP/EC sysIO Usage Guide (TN1056)
- LatticeECP/EC sysCLOCK PLL Design and Usage Guide (TN1049)
- Memory Usage Guide for LatticeECP/EC Devices (TN1051)
- LatticeECP/EC DDR Usage Guide (TN1050)
- Power Estimation and Management for LatticeECP/EC and LatticeXP Devices (TN1052)
- LatticeECP-DSP sysDSP Usage Guide (TN1057)
- LatticeECP/EC sysCONFIG Usage Guide (TN1053)
- IEEE 1149.1 Boundary Scan Testability in Lattice Devices

For further information about interface standards refer to the following web sites:

- JEDEC Standards (LVTTL, LVCMOS, SSTL, HSTL): www.jedec.org
- PCI: ww.pcisig.com